Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inv	ventor, I hereby decl	are that:	
My residence, post of	fice address and citiz	zenship are as stated below next to m	y name,
first and joint inventor and for which a paten METHOD FOR MANU the specification of whomas was filed on Aproperties and was amended thereby state that I have and for the specific accordance with the specific accordance	(if plural names are t is sought on the inv JFACTURING A MUnich is attached here il 19, 1999 plication Number or ed on (if applicable ave reviewed and un	JLTI-LAYERED CERAMIC SUBSTRATE ounless the following box is checked as PCT International Application Number	ich is claimed TE , : r PCT/JP99/02079
I acknowledge the dut 1.56.	ty to disclose informa	ation which is material to patentability	as defined in 37 CFR §
application(s) for pate designated at least o below by checking t	ent or inventor's certione country other the the box, any foreigon having a filing date	under 35 U.S.C. §119(a)-(d) or § ificate, or § 365(a) of any PCT Internation the United States, listed below a gn application for patent or inventote before that of the application on whi	ational application which and have also identified or's certificate, or PC
10-114671	<u>Japan</u>	24 April 1998	•
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the be listed below.	enefit under 35 U.S	.C. § 119(e) of any United States p	rovisional application(s
—— (Application Number)	(Filing Date)		
—— (Application Number)	(Filing Date)		
	olication designating	C. § 120 of any United States applicate the United States, listed below and	

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.G. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

— (Application Number)		(Filing Date)	— (Status - pate	 (Status - patented, pending, abandoned)		
—— (Application Number)		(Filing Date)	(Status - pate	(Status - patented, pending, abandoned)		
	secute this app	a named inventor, lication and transac				
Paul F. Prestia Allan Ratner Andrew L. Ney Kenneth N. Nigon Kevin R. Casey Benjamin E. Leace James C. Simmons	Reg. No. 23,031 Reg. No. 19,717 Reg. No. 20,300 Reg. No. 31,549 Reg. No. 32,117 Reg. No. 33,412 Reg. No. 24,842	Lawrence E. Ashery Christopher R. Lewis Robert L. Andersen Daniel N. Calder Louis W. Beardell, Jr. Jacques L. Etkowicz, Eric A. Dichter	Reg. No. 34,515 Reg. No. 36,201 Reg. No. 25,771 Reg. No. 27,424 Reg. No. 40,506 Reg. No. 41,738 Reg. No. 41,708	Mark J. Marcelli Joshua L. Cohen Jack J. Jankovitz	Reg. No. 36,593 Reg. No. 38,040 Reg. No. 42,690	
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statements madwere made with by fine or impris	e on informatio the knowledge conment, or bot statements ma	tatements made her and belief are belen that willful false the under Section 10 ty jeopardize the vali	ieved to be true statements and 001 of Title 18 of the applications.	e; and further that d the like so mad of the United State	these statements de are punishable es Code and that	
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Additional inve	entors are being na	med on senarately numbe	ired sheets attached	herete		

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